STF12N60M2



N-channel 600 V, 0.395 Ω typ., 9 A MDmesh™ M2 Power MOSFET in a TO-220FP package

Datasheet - production data

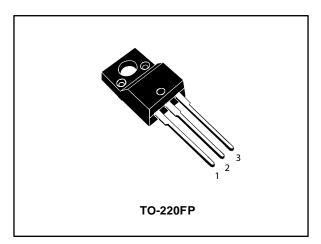
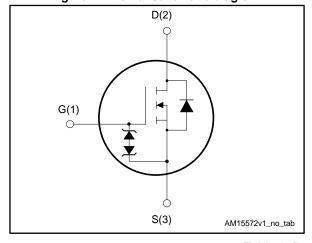


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	I _D	Ртот
STF12N60M2	600 V	0.450 Ω	9 A	25 W

- Extremely low gate charge
- Excellent output capacitance (C_{OSS}) profile
- 100% avalanche tested
- Zener-protected

Applications

Switching applications

Description

This device is an N-channel Power MOSFET developed using MDmesh™ M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.

Table 1: Device summary

Order code	Marking	Package	Packing
STF12N60M2	12N60M2	TO-220FP	Tube

Contents STF12N60M2

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STF12N60M2 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{GS}	Gate-source voltage	±25	V
I _D ⁽¹⁾	Drain current (continuous) at T _{case} = 25 °C	9	Α
ID	Drain current (continuous) at T _{case} = 100 °C	5.7	А
I _{DM} ⁽²⁾	Drain current (pulsed)	36	Α
P _{TOT}	Total dissipation at T _{case} = 25 °C	25	W
dv/dt ⁽³⁾	Peak diode recovery voltage slope	15	V/ns
dv/dt ⁽⁴⁾	MOSFET dv/dt ruggedness	50	V/IIS
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; T_C = 25 °C)	2.5	kV
T _{stg}	Storage temperature	-55 to 150	
T _j	Maximum junction temperature	150	°C

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	5	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	62.5	

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR} ⁽¹⁾	Avalanche current, repetitive or not repetitive	2.6	Α
E _{AR} ⁽²⁾	Single pulse avalanche energy	117	mJ

Notes:

⁽¹⁾ Limited by maximum junction temperature.

 $^{^{\}left(2\right) }$ Pulse width is limited by safe operating area.

 $^{^{(3)}}$ $I_{SD} \leq 9$ A, di/dt=400 A/µs; $V_{DS}(peak) < V_{(BR)DSS}, \, V_{DD} = 80\% \ V_{(BR)DSS}.$

 $^{^{(4)}} V_{DS} \le 480 V.$

 $^{^{\}left(1\right)}$ Pulse width limited by $T_{jmax}.$

 $^{^{(2)}}$ starting T_{j} = 25 °C, I_{D} = $I_{AR},\,V_{DD}$ = 50 V.

Electrical characteristics STF12N60M2

2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Table 5: Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	600			V
	Zara gata valtaga drain	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V}$			1	
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V},$ $T_{case} = 125 \text{ °C}$			100	μΑ
I _{GSS}	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$			±10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, I_D = 4.5 \text{ A}$		0.395	0.450	Ω

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	538	-	
Coss	Output capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$	-	29	-	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0 V$	-	1.1	-	Pi
Coss (1)	Equivalent output capacitance	$V_{DS} = 0$ to 480 V, $V_{GS} = 0$ V	-	106	-	pF
R_{G}	Intrinsic gate resistance	f = 1 MHz, I _D = 0 A	-	7	-	Ω
Q_g	Total gate charge	$V_{DD} = 400 \text{ V}, I_D = 9 \text{ A},$	-	16	-	
Q _{gs}	Gate-source charge	V _{GS} = 10 V (see <i>Figure 15</i> :	-	2.3	-	nC
Q_gd	Gate-drain charge	"Gate charge test circuit")	-	8.5	-	

Notes:

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Table 7: Switching times

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Symbo I	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
t _{d(on)}	Turn-on delay time	$V_{DD} = 300 \text{ V}, I_D = 4.5 \text{ A}$	-	9.2	-		
t _r	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 14: "Switching times	-	9.2	-		
t _{d(off)}	Turn-off delay time	test circuit for resistive load"	-	56	-	ns	
t _f	Fall time	and Figure 19: "Switching time waveform")	-	18	-		

 $^{^{(1)}}$ $C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS} .

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		9	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		36	Α
V _{SD} ⁽²⁾	Forward on voltage	$V_{GS} = 0 \text{ V}, I_{SD} = 9 \text{ A}$	-		1.6	V
t _{rr}	Reverse recovery time	$I_{SD} = 9 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	284		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V (see Figure 16: "Test circuit for inductive	-	2.4		μC
I _{RRM}	Reverse recovery current	load switching and diode recovery times")	-	20.5		Α
t _{rr}	Reverse recovery time	$I_{SD} = 9 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	454		ns
Q _{rr}	Reverse recovery charge	$V_{DD} = 60 \text{ V}, T_j = 150 ^{\circ}\text{C} \text{ (see}$ Figure 16: "Test circuit for	-	4.8		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	21		Α

Notes:

⁽¹⁾ Pulse width is limited by safe operating area.

⁽²⁾ Pulse test: pulse duration = 300 μ s, duty cycle 1.5%.

2.1 Electrical characteristics (curves)

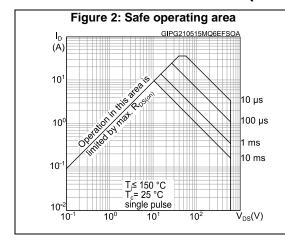
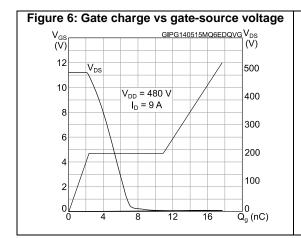
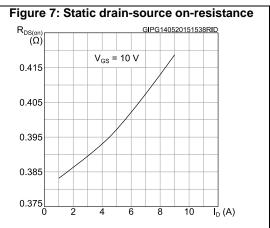


Figure 3: Thermal impedance K GC20940 δ = 0.5 δ = 0.05 δ = 0.02 δ = 0.01 Single pulse δ = δ =





STF12N60M2 Electrical characteristics

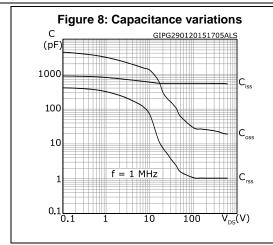


Figure 9: Normalized gate threshold voltage vs temperature

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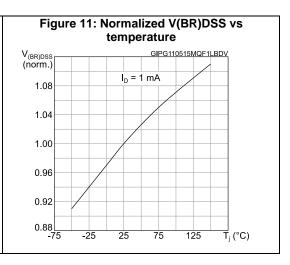
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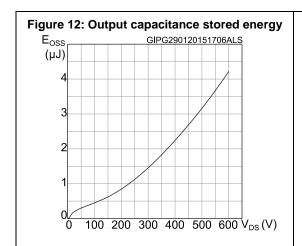
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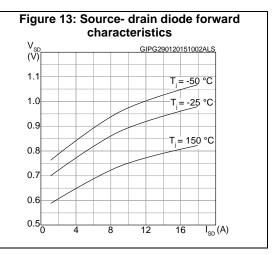
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Figure 10: Normalized on-resistance vs temperature R_{DS(on)} (norm.) GIPG110515MQF1LRON V_{GS} = 10 V 2.2 1.8 1.4 1.0 0.6 0.2 -75 -25 25 75 125 T_i (°C)



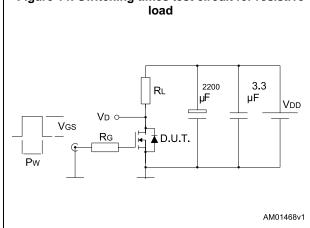




Test circuits STF12N60M2

3 Test circuits





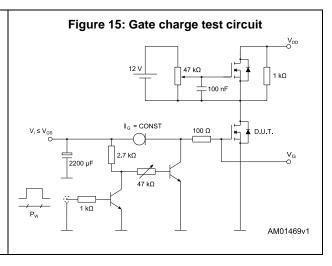


Figure 16: Test circuit for inductive load switching and diode recovery times

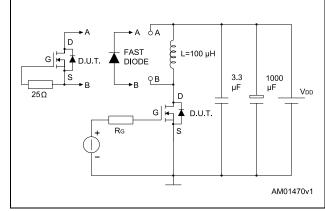
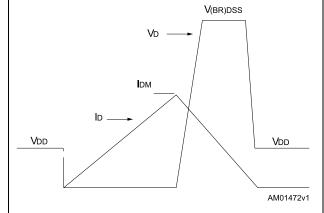
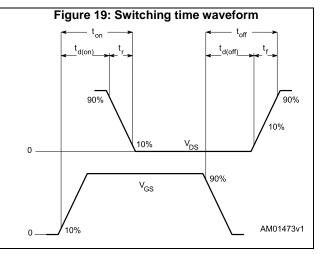


Figure 17: Unclamped inductive load test circuit

Figure 18: Unclamped inductive waveform





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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of $\mathsf{ECOPACK}^{\otimes}$ packages, depending on their level of environmental compliance. $\mathsf{ECOPACK}^{\otimes}$ specifications, grade definitions and product status are available at: www.st.com. $\mathsf{ECOPACK}^{\otimes}$ is an ST trademark.



4.1 TO-220FP package information

Figure 20: TO-220FP package outline

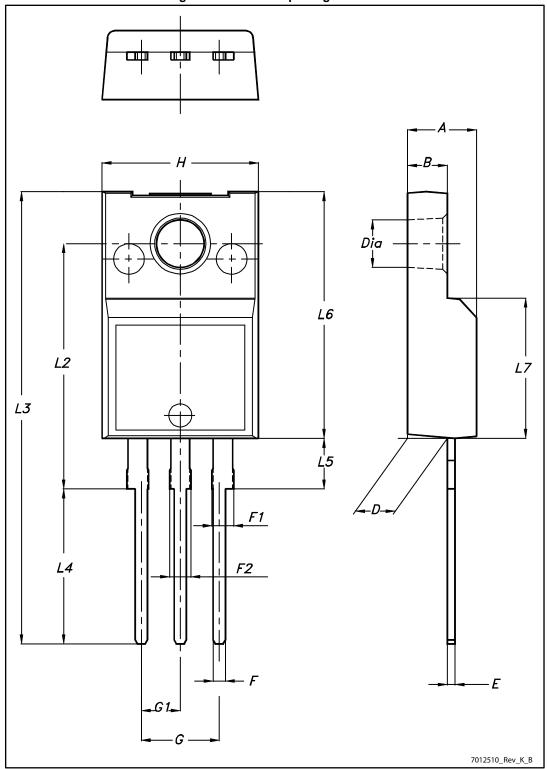


Table 9: TO-220FP package mechanical data

Dim	mm		
Dim.	Min.	Тур.	Max.
А	4.4		4.6
В	2.5		2.7
D	2.5		2.75
Е	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
Н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2

Revision history STF12N60M2

5 Revision history

Table 10: Document revision history

Date	Revision	Changes
22-May-2015	1	First release.

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